20V N -Channel Enhancement Mode MOSFET

WGEN06V20

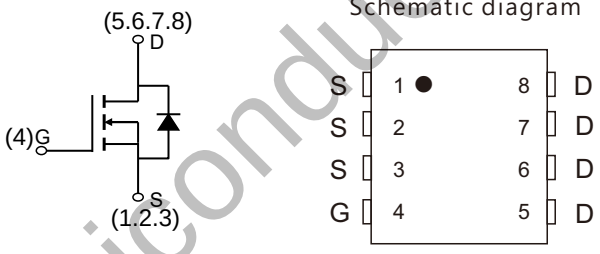
PDFN3*3

RoHS COMPLIANT



Features:

- ☐ Low Intrinsic Capacitances.
- ☐ Excellent Switching Characteristics.
- ☐ Extended Safe Operating Area.
- ☐ Unrivalled Gate Charge :Qg=42 nC (Typ.).
- ☐ VDSS=20 V,I_D=11A
- ☐ R_{DS}(on) : 7 mΩ (Max) @V_G=4.5V
- ☐ 100% Avalanche Tested



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Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	±12	V
Drain Current-Continuous	I_D	11	A
Drain Current-Continuous(T_A=100℃)	I_D (100℃)	8	A
Pulsed Drain Current	I_{DM}	40	A
Maximum Power Dissipation	P_D	2.5	W
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 150	℃

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient(Note 2)	$R_{\theta JA}$	50	℃/W

Electrical Characteristics (T_A=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=250μA	20	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=20V,V_{GS}=0V	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±12V,V_{DS}=0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250μA	0.5	0.8	1.2	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=4.5V, I_D=6A	-	5.6	7.0	mΩ
		V_{GS}=2.5V, I_D=5A		8	11	
Forward Transconductance	g_{FS}	V_{DS}=10V,I_D=6A	20	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C_{lss}	V_{DS}=10V,V_{GS}=0V, F=1.0MHz	-	2000	-	PF
Output Capacitance	C_{oss}		-	402	-	PF
Reverse Transfer Capacitance	C_{rss}		-	170	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=10V,I_D=6A V_{GS}=4. 5V,R_{GEN}=1Ω	-	25	-	nS
Turn-on Rise Time	t_r		-	15	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	25	-	nS
Turn-Off Fall Time	t_f		-	15	-	nS
Total Gate Charge	Q_g	V_{DS}=10V,I_D=6A, V_{GS}=10V	-	42	-	nC
Gate-Source Charge	Q_{gs}		-	10.8	-	nC
Gate-Drain Charge	Q_{gd}		-	9.2	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS}=0V,I_S=6A	-	-	1.2	V
Diode Forward Current (Note 2)	I_S		-	-	11	A

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

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Typical Electrical and Thermal Characteristics (Curves)

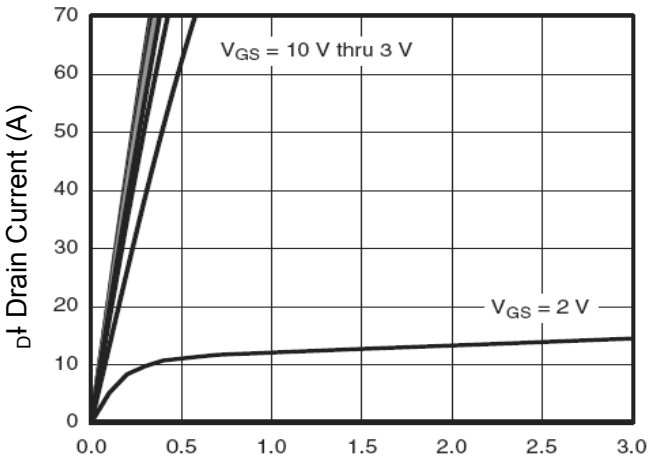


Figure 1 Output Characteristics

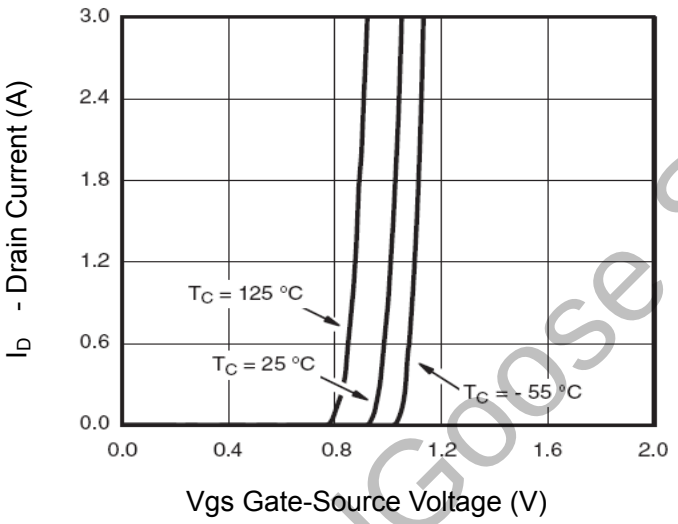


Figure 2 Transfer Characteristics

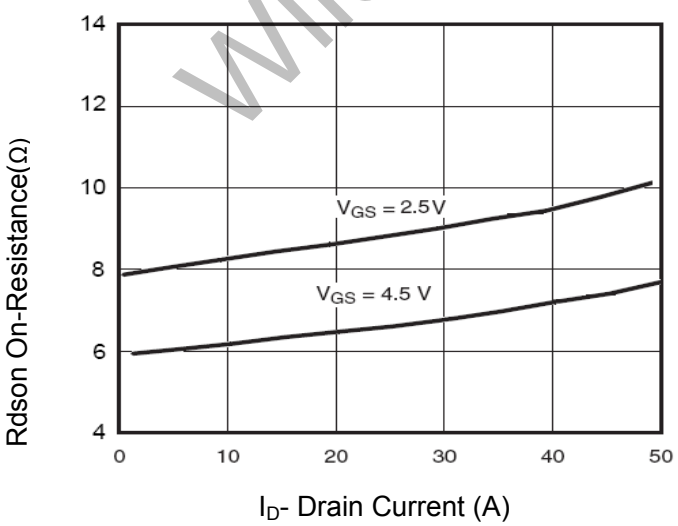


Figure 3 Rdson- Drain Current

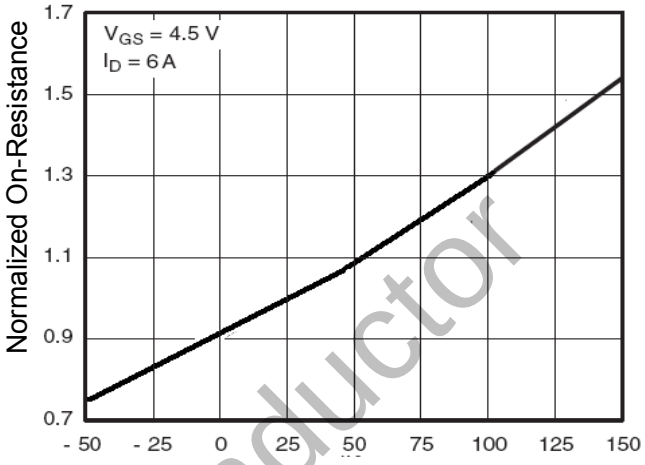


Figure 4 Rdson-Junction Temperature

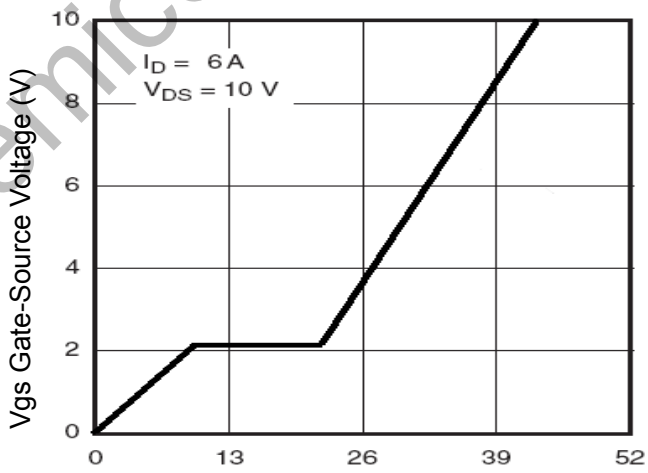


Figure 5 Gate Charge

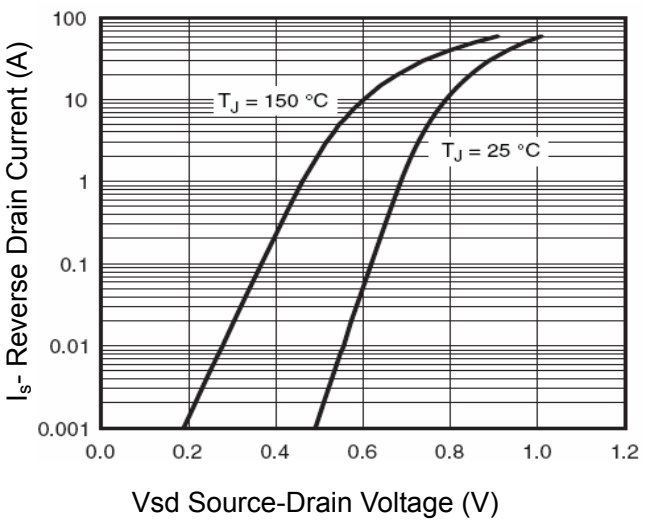


Figure 6 Source- Drain Diode Forward

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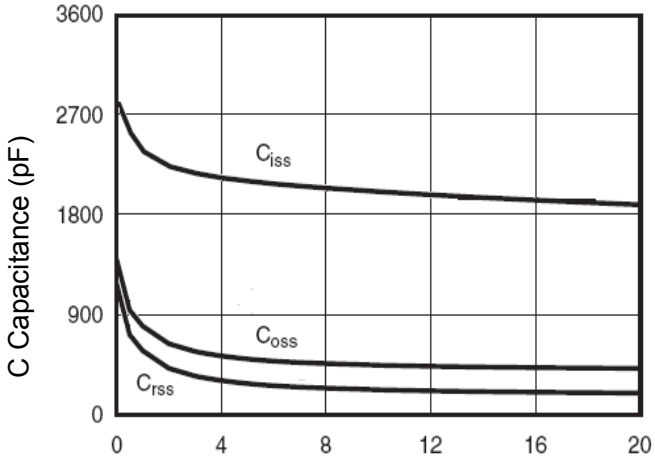


Figure 7 Capacitance vs Vds

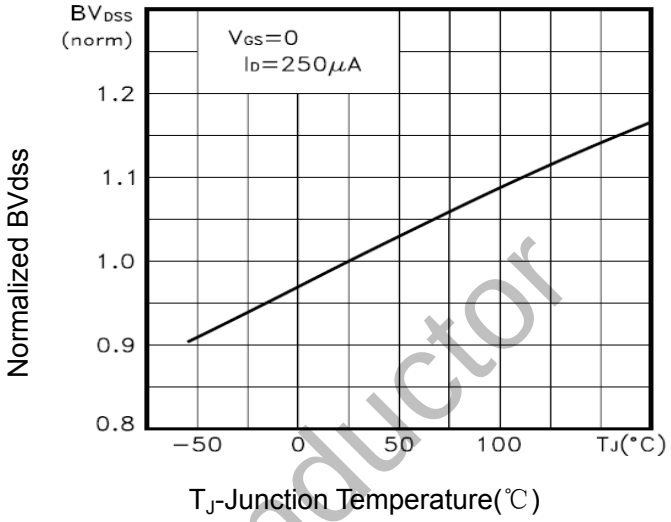


Figure 9 BV_{DSS} vs Junction Temperature

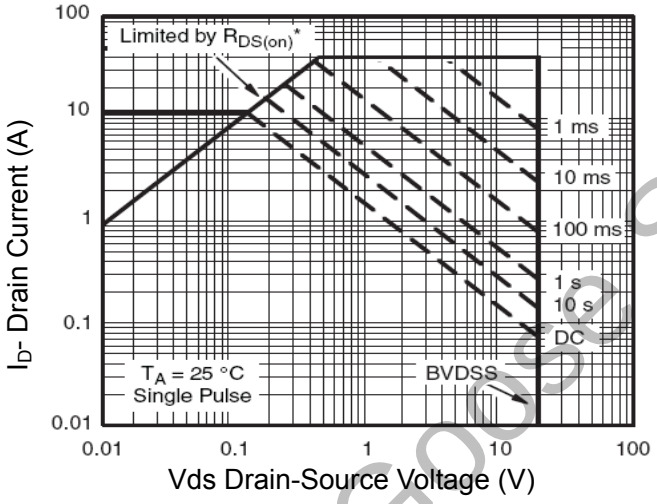


Figure 8 Safe Operation Area

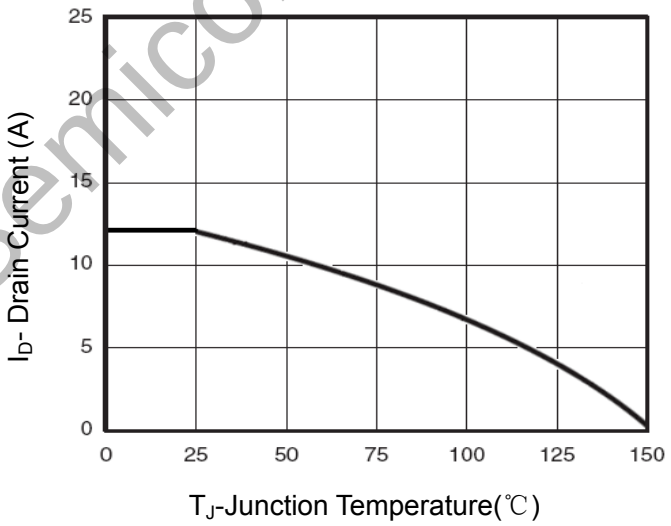


Figure 10 Current vs Junction Temperature

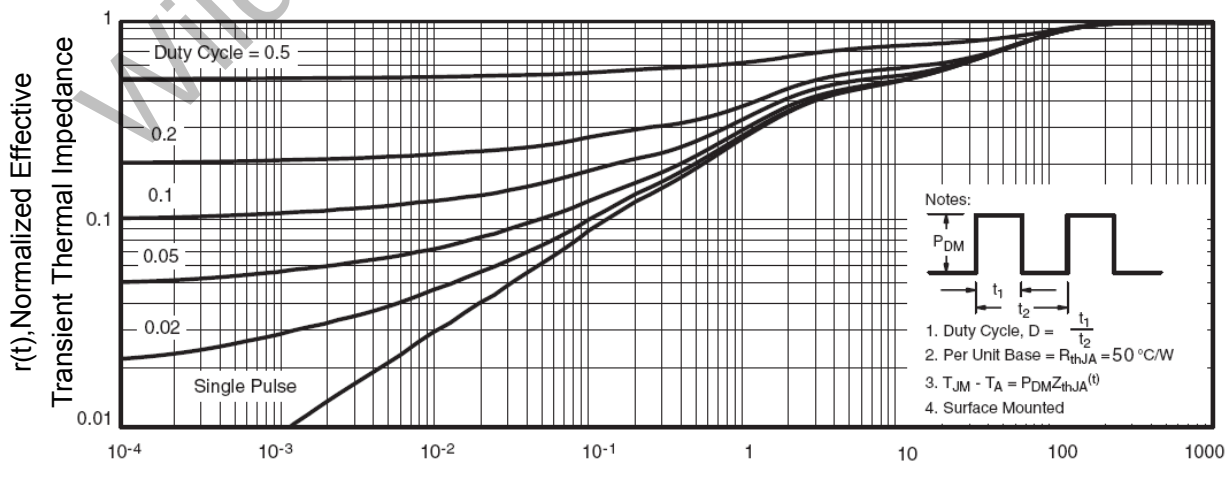


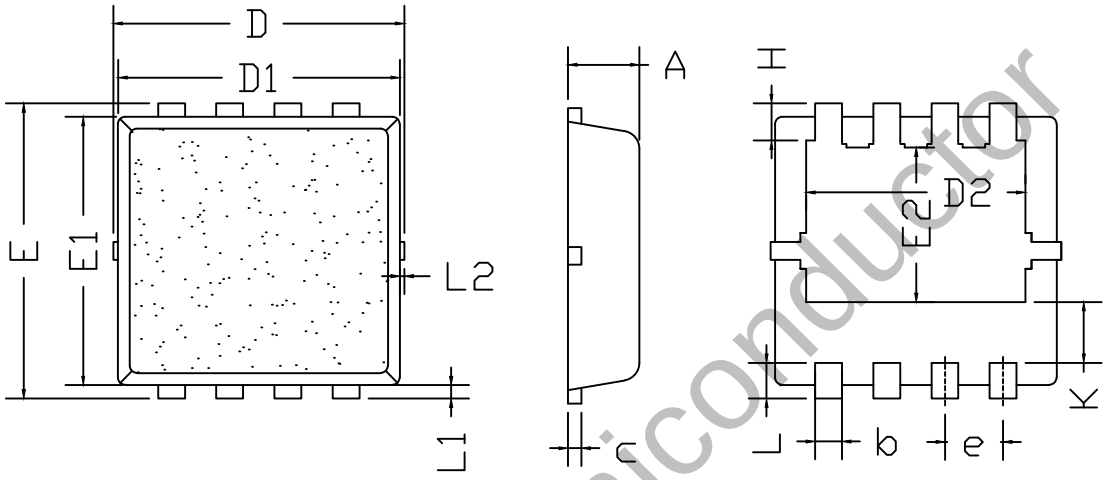
Figure 11 Normalized Maximum Transient Thermal Impedance

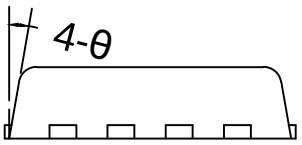
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Package Dimension

PDFN3*3

Unit:mm





SYMBOL	mm		
	MIN	NOM	MAX
*A	0.70	0.80	0.90
*b	0.25	0.30	0.35
*c	0.20	0.25	0.30
D	3.25BSC		
*D1	3.05	3.15	3.25
D2	2.35	2.45	2.55
*e	0.55	0.65	0.75
E	3.30BSC		
*E1	2.90	3.00	3.10
E2	1.64	1.74	1.84
H	0.32	0.42	0.52
K	0.58	0.68	0.78
L	0.30	0.40	0.50
L1	0.10	0.15	0.20
L2	–	–	0.12
θ	8°	10°	12°

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